

No Drawing Available.
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Dimensions	
Footprint	3825
L	3.81mm +/-0.38mm
W	2.54mm +/-0.38mm
H	1.27mm +/-0.38mm
S	0.76mm +0.25/-0.13mm
F	2.41mm +0.13/-0.25mm
K	0.76mm MIN
P	0.38mm MIN

Packaging Specifications	
Packaging	Bulk, Bag

General Information	
Series	T429 CWR29
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, Military Equivalent, Low ESR
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	573c56ea-c4cc-4850-b749-53802fe9068f
Termination	Hot Solder Dipped
Qualifications	MIL-PRF-55365/11, CWR29 Style
AEC-Q200	No
Component Weight	264.12 mg
Notes	Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S".
MSL	1

Specifications	
Capacitance	15 uF
Capacitance Tolerance	10%
Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	C (0.01%/1000 Hrs)
Resistance	1.7 Ohms (100kHz 25C)
Ripple Current	217 mA (rms, 100kHz 25C)
Leakage Current	2 uA (5min 25°C)
Testing and Reliability	Surge Testing At 25C After Weibull

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